IGBT - Short-Circuit Rated

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Non–Punch Through (NPT) Trench construction, and provides superior performance in demanding switching applications. Offering both low on state voltage and minimal switching loss, the IGBT is well suited for motor drive control and other hard switching applications.

Features

- Low Saturation Voltage Resulting in Low Conduction Loss
- Low Switching Loss in Higher Frequency Applications
- 5 µs Short Circuit Capability
- Excellent Current versus Package Size Performance Density
- This is a Pb–Free Device

Typical Applications

- White Goods Appliance Motor Control
- General Purpose Inverter
- AC and DC Motor Control

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	600	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι _C	30 15	A
Pulsed collector current, T_{pulse} limited by T_{Jmax}	I _{CM}	120	A
Gate-emitter voltage	V_{GE}	±20	V
Power dissipation @ Tc = 25°C @ Tc = 100°C	P _D	117 47	W
Short circuit withstand time V_{GE} = 15 V, V_{CE} = 400 V, T_J $\leq~$ +150°C	t _{SC}	5	μS
Operating junction temperature range	ТJ	–55 to +150	°C
Storage temperature range	T _{stg}	–55 to +150	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

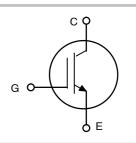
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

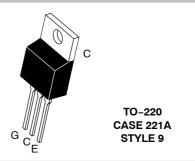


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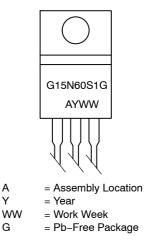
http://onsemi.com

15 A, 600 V V_{CEsat} = 1.5 V





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTG15N60S1EG	TO-220 (Pb-Free)	50 Units / Rail

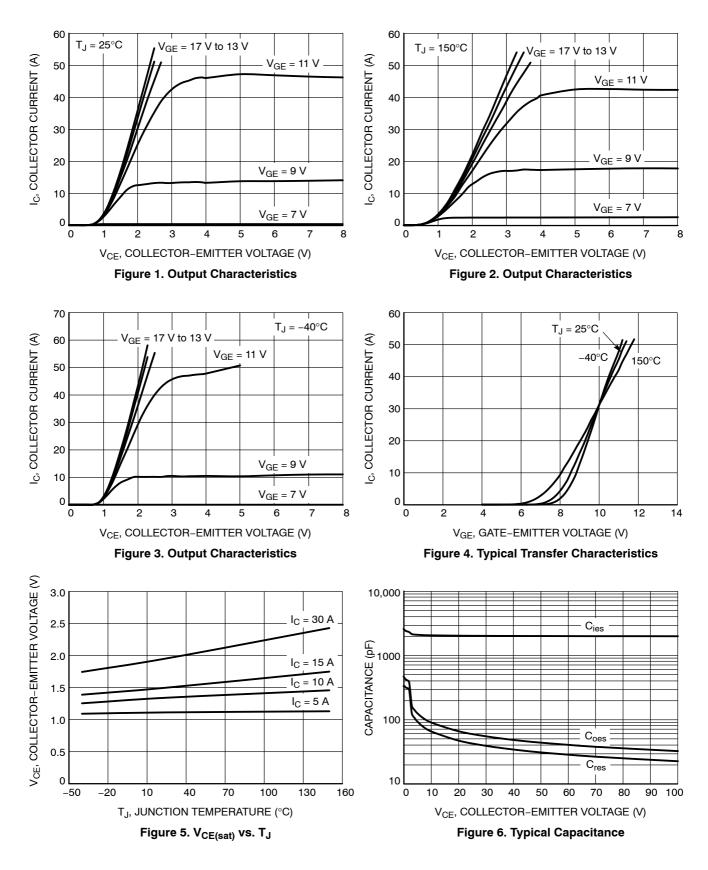
THERMAL CHARACTERISTICS

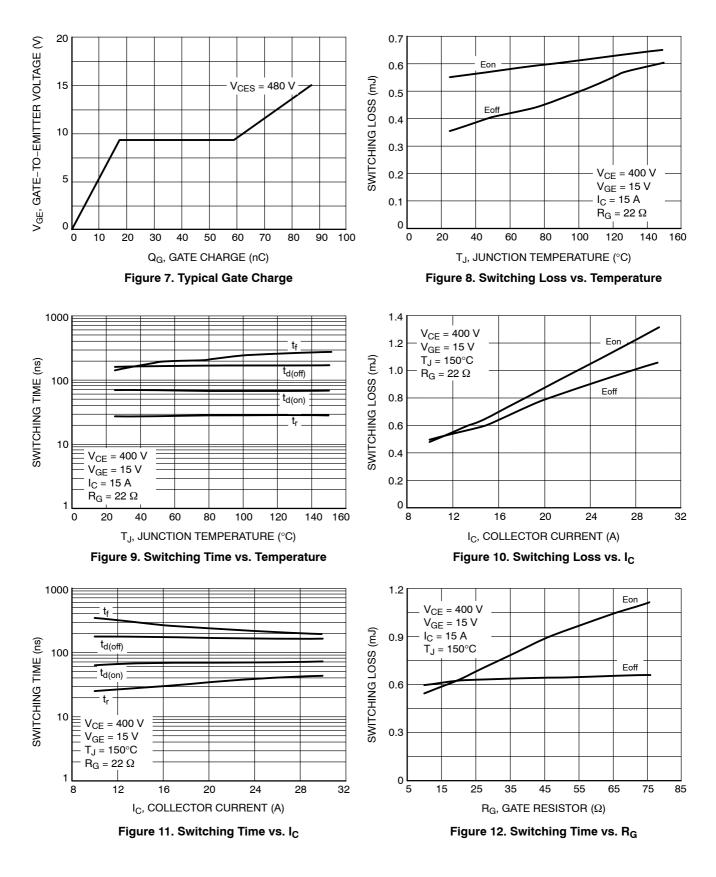
Rating	Symbol	Value	Unit
Thermal resistance junction to case, for IGBT	$R_{\theta JC}$	1.06	°C/W
Thermal resistance junction to ambient	$R_{ hetaJA}$	60	°C/W

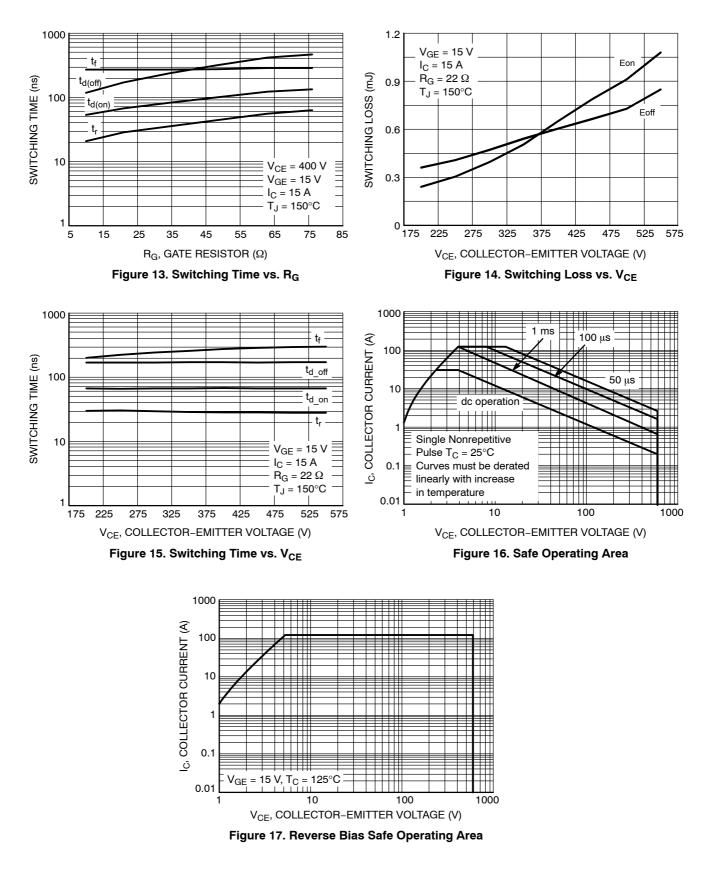
ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit	
STATIC CHARACTERISTIC		-		•	•	<u></u>	
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I_C = 500 μA	V _{(BR)CES}	600	-	-	V	
Collector-emitter saturation voltage	V_{GE} = 15 V , I _C = 15 A V _{GE} = 15 V , I _C = 15 A, T _J = 150°C	V _{CEsat}	1.3 1.55	1.5 1.75	1.7 1.95	V	
Gate-emitter threshold voltage	V_{GE} = V_{CE} , I_C = 250 μ A	V _{GE(th)}	4.5	5.5	6.5	V	
Collector-emitter cut-off current, gate-emitter short-circuited	V_{GE} = 0 V, V_{CE} = 600 V V_{GE} = 0 V, V_{CE} = 600 V, T_{J} = 150°C	I _{CES}	-	10 -	_ 200	μΑ	
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V, V_{CE} = 0 V	I _{GES}	-	-	100	nA	
Forward Transconductance	V_{CE} = 20 V, I_{C} = 15 A	9fs	-	10.1	-	S	
DYNAMIC CHARACTERISTIC							
Input capacitance		C _{ies}	-	1950	-		
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C _{oes}	-	70	-	pF	
Reverse transfer capacitance		C _{res}	-	48	-	pF	
Gate charge total		Qg	-	88	-		
Gate to emitter charge	V_{CE} = 480 V, I _C = 15 A, V _{GE} = 15 V	Q _{ge}	-	16	-	nC	
Gate to collector charge		Q _{gc}	-	42	-		
SWITCHING CHARACTERISTIC , INDUCTIVE	LOAD						
Turn-on delay time		t _{d(on)}	-	65	-		
Rise time		t _r	-	28	-		
Turn-off delay time	T _J = 25°C	t _{d(off)}	-	170	-	ns	
Fall time	$V_{CC} = 400 \text{ V}, I_C = 15 \text{ A}$ B ₂ = 22 Q	t _f	-	140	-		
Turn-on switching loss	$R_g = 22 \Omega$ $V_{GE} = 0 V / 15 V^*$	Eon	-	0.550	-		
Turn-off switching loss		E _{off}	-	0.350	-	mJ	
Total switching loss		E _{ts}	-	0.900	-		
Turn-on delay time		t _{d(on)}	-	65	-		
Rise time		t _r	-	28	-		
Turn-off delay time	T.I = 150°C	t _{d(off)}	-	180	-	ns	
Fall time	V _{CC} = 400 V, I _C = 15 A	t _f	-	260	-		
Turn-on switching loss	R _g = 22 Ω V _{GE} = 0 V / 15 V*	E _{on}	-	0.650	-		
Turn-off switching loss		E _{off}	-	0.600	-	mJ	
Total switching loss		E _{ts}	-	1.250	-		

*Includes diode reverse recovery loss using NGTB15N60S1EG.







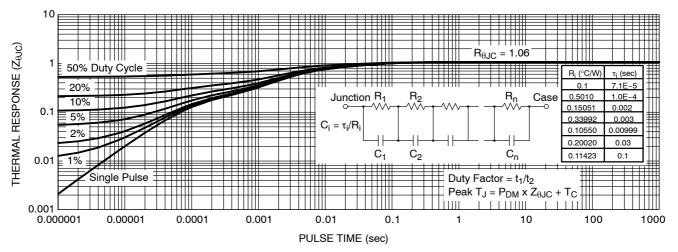


Figure 18. IGBT Transient Thermal Impedance

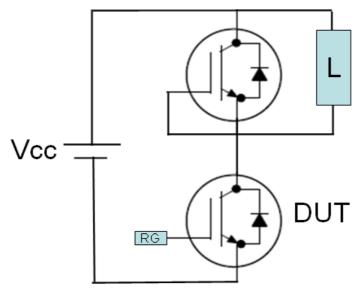
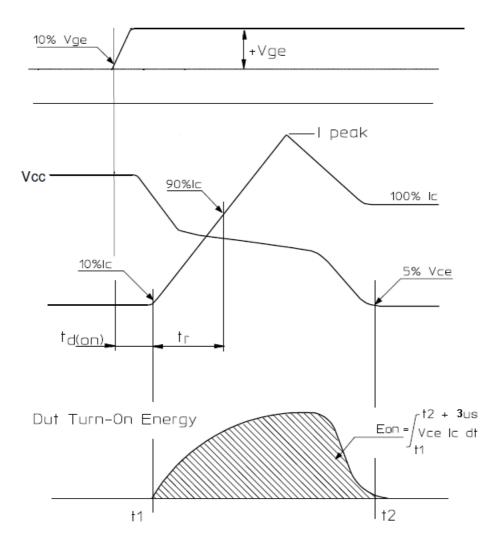


Figure 19. Test Circuit for Switching Characteristics





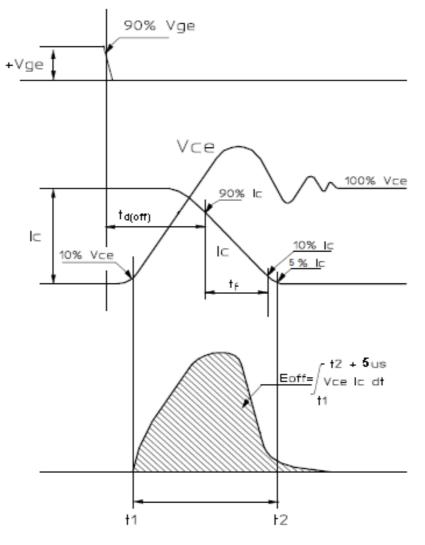
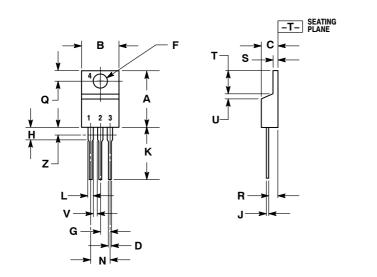


Figure 21. Definition of Turn Off Waveform

PACKAGE DIMENSIONS

TO-220 CASE 221A-09 ISSUE AG



DIMENSION Z DEFINES A ZONE WHERE AI BODY AND LEAD IRREGULARITIES ARE ALLOWED.					
	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.036	0.64	0.91	
F	0.142	0.161	3.61	4.09	
G	0.095	0.105	2.42	2.66	
н	0.110	0.161	2.80	4.10	
J	0.014	0.025	0.36	0.64	
K	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
N	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
V	0.045		1.15		
z		0.080		2.04	

1. DIMENSIONING AND TOLERANCING PER ANSI

CONTROLLING DIMENSION: INCH

STYLE 9: PIN 1. GATE

NOTES:

2

3.

Y14.5M, 1982.

2. COLLECTOR 3. EMITTER

4. COLLECTOR

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